

SY100EL33L

3.3V ECL ÷ 4 Divider

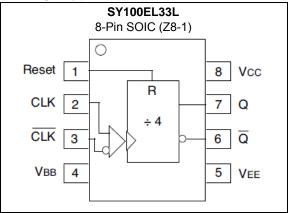
Features

- 3.3V Power Supply
- 640ps Propagation Delay (typical)
- 4.2 GHz Toggle Frequency (typical)
- High Bandwidth Output Transitions
- Internal 75 kΩ Input Pull-Down Resistors
- Available in 8-Pin SOIC Package

General Description

The SY100EL33L is an integrated ÷4 divider. The differential clock inputs and the V_{BB} allow a differential, single-ended or AC-coupled interface to the device. If used, the V_{BB} output should be bypassed to ground with a 0.01µF capacitor. Also note that the V_{BB} is designed to be used as an input bias on the EL33L only; the V_{BB} output has limited current sink and source capability. The Reset pin is asynchronous and is asserted on the rising edge. Upon power-up, the internal flip-flops will attain a random state; the Reset input allows for the synchronization of multiple EL33Ls in a system.

Package Type



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings †

PECL Power Supply Voltage (Vcc) (Note 1)	+8V
NECL Power Supply Voltage (VEE) (Note 2)	
PECL Mode Input Voltage (VIN) (Note 3)	+6V
NECL Mode Input Voltage (VIN) (Note 4)	6V
Continuous Output Currrent (IOUT).	50mA
Surge Output Currrent (IOUT)	100mA

† Notice: Stresses above those listed under "Absolute Maximum ratings" may cause permanent damage to the device. Exposure to maximum rating conditions for extended periods may affect device reliability.

- **Note 1:** VEE = 0V
 - 2: Vcc = 0V
 - **3:** VEE = 0V, VIN \leq VCC
 - **4:** VCC = 0V, VIN ≥ VEE

TABLE 1-1: DC ELECTRICAL CHARACTERISTICS

Electrical Characteristics PECL: Vcc = 3.0V to 3.8V; VEE = 0V; TA = -40°C to 85°C, unless otherwise stated (Note 1)

_			_			
Parameter	Symbol	Min.	Тур.	Max.	Units	Test Condition
Power Supply Voltage	Vcc	3.0	3.3	3.8	V	
Dower Supply Current	lee	—	27	33	m (TA = -40°C to +25°C
Power Supply Current	IEE	—	31	37	mA	TA = +85°C
Output High Voltage (Note 2)	Mou	Vcc - 1.085	Vcc - 1.005	Vcc – 0.88	V	TA = -40°C
Output High Voltage (Note 2)	Vон	Vcc - 1.025	Vcc - 0.955	Vcc - 0.88	V	TA = 0°C to 85°C
Output Low Voltage (Nate 2)	Vol	Vcc - 1.830	Vcc – 1.695	Vcc – 1.555	V	TA = -40°C
Output Low Voltage (Note 2)		Vcc - 1.810	Vcc – 1.705	Vcc - 1.620		TA = 0°C to 85°C
Input High Voltage (Single Ended)	Vih	Vcc – 1.165	—	Vcc - 0.880	V	
Input Low Voltage (Single Ended)	VIL	Vcc - 1.810	—	Vcc – 1.475	V	
Output Reference Voltage	VBB	Vcc – 1.38	_	Vcc – 1.26	V	
Input High Current	Іін	_	_	150	μA	
Input Low Current	١L	0.5	—	—	μA	VIN = VIL (Min)

Note 1: Devices are designed to meet the DC specifications shown in the above table after thermal equilibration has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500lfpm is maintained.

2: Outputs are terminated through a 50 Ω resistor to Vcc – 2.0V.

Parameter	Symbol	Min.	Тур.	Max.	Units	Test Condition
Power Supply Voltage	VEE	-3.8	-3.3	-3	V	
Device Current Current	lee	_	27	33		$T_A = -40^{\circ}C$ to $+25^{\circ}C$
Power Supply Current	IEE	_	31	37	mA	TA = +85°C
Output Lligh Valtage (Nate 2)	Mari	-1.085	-1.005	-0.88	N	TA = -40°C
Output High Voltage (Note 2)	Vон	-1.025	-0.955	-0.88	V	TA = 0°C to 85°C
	Vol	-1.830	-1.695	-1.555	V	TA = -40°C
Output Low Voltage (Note 2)		-1.810	-1.705	-1.620		TA = 0°C to 85°C
Input High Voltage (Single Ended)	Vін	-1.165	—	-0.880	V	
Input Low Voltage (Single Ended)	VIL	-1.810	_	-1.475	V	
Output Reference Voltage	VBB	-1.380	_	-1.260	V	
Input High Current	Ін	_	_	150	μA	
Input Low Current	lı∟	0.5	_	_	μA	VIN = VIL (Min)

TABLE 1-2: DC ELECTRICAL CHARACTERISTICS

Electrical Characteristics NECL: VEE = -3.8V to -3.0V; Vcc = 0V; TA = -40°C to 85°C, unless otherwise stated (Note 1)

Note 1: Devices are designed to meet the DC specifications shown in the above table after thermal equilibration has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500lfpm is maintained.

2: Outputs are terminated through a 50 Ω resistor to Vcc – 2.0V.

TABLE 1-3: AC ELECTRICAL CHARACTERISTICS⁽¹⁾

Electrical Characteristics: Vcc = 3.0V to 3.8V; VEE = 0V or VEE = -3.8V to -3.0V; Vcc = 0V; TA = -40° C to 85° C, unless otherwise stated

Parameter	Symbol	Min.	Тур.	Max.	Units	Test Condition
Maximum Toggle Frequency	f _{MAX}	3.8	4.2	—	GHz	
		490	630	770	ps	TA = -40°C
Drag Dalay OLK to O		540	630	720	ps	TA = 0°C
Prop. Delay CLK to Q	t _{PD}	550	640	730	ps	TA = +25°C
		590	670	760	ps	TA = +85°C
	t _{PD}	310	460	610	ps	TA = -40°C
Propagation Delay RESET to Q		360	460	560	ps	TA = 0° C to +25°C
		380	480	580	ps	TA = +85°C
Input Swing (Note 1)	V _{PP}	100	—	1000	mV	
Output Rise/Fall Time Q (20% to 80%)	t _{r/} t _f	100	225	350	ps	

Note 1: Input swing for which AC parameters are ensured.

TEMPERATURE SPECIFICATIONS

Parameters	Sym.	Min.	Тур.	Max.	Units	Conditions
Temperature Ranges						
Operating Temperature Range	T _A	-40		+85	°C	—
Storage Temperature	Τ _S	-65	_	+150	°C	—
Lead Temperature	T _{LEAD}	_	_	+260	°C	Soldering, 20 sec.

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2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

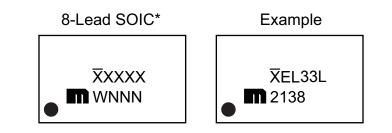
Pin Number	Pin Name	Description							
1	Reset	Asynchronous Reset							
2, 3	CLK, /CLK	Clock Inputs							
4	V _{BB}	Reference Voltage Output							
5	V _{EE}	Negative Power Supply							
6, 7	Q, /Q	Data Outputs							
8	V _{CC}	Positive Power Supply							

TABLE 2-1: PIN FUNCTION TABLE

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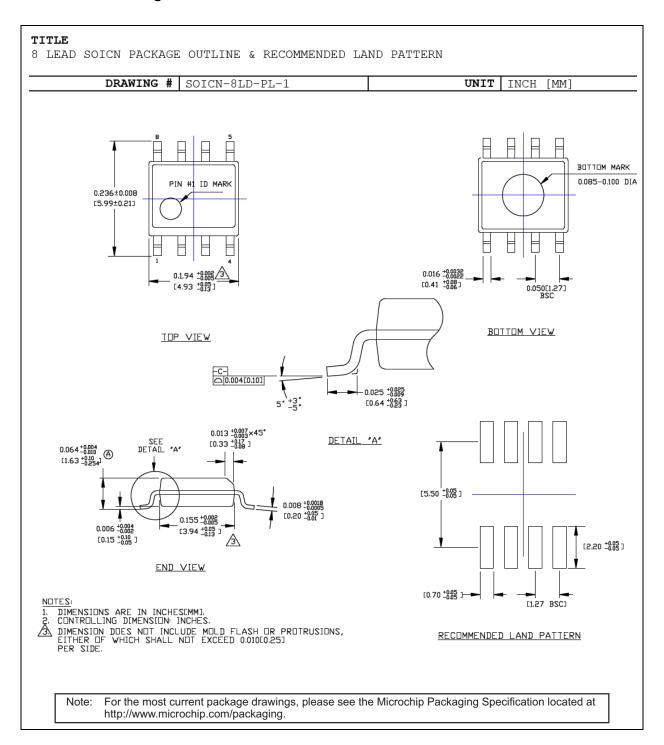
3.0 PACKAGING INFORMATION

3.1 Package Marking Information



Legend	Y YY WW NNN @3 *	Product code or customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC [®] designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package. ' Pin one index is identified by a dot, delta up, or delta down (triangle
Note:	be carried characters the corpor	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available for customer-specific information. Package may or may not include ate logo. (_) and/or Overbar (⁻) symbol may not be to scale.
	Underbai	

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8-Lead SOIC Package Outline and Recommended Land Pattern

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PRODUCT IDENTIFICATION SYSTEM

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PART N	n x x	-XX Ex	Examples:		
Device	- T T	a) Special Processing	SY100EL33LZG ⁽³⁾ SY100EL33LZG-TR ^(2,3)	8-Lead SOIC (Z8-1) pack- age, -40°C to +85°C Industrial Temp. (Pb-Free NiPdAu), 95/Tube 8-Lead SOIC (Z8-1) pack-	
Device:	3.3V ÷ 4 Divider SY100EL33L			age, -40°C to +85°C Industrial Temp. (Pb-Free NiPdAu), 1,000/Reel	
Package	Z = 8-Lead SOIC				
Temperature Range:	G = -40° C to $+85^{\circ}$ C (Pb-	Free NiPdAu)			
Special Processing:	<blank>= 95/Tube TR = 1,000/Reel</blank>				
Electric 2: Tape ar	factory for die availability. Dice are als only. d Reel. a package is recommended for nev	e ensured at T _A = 25°C, DC	catalog part nun fier is used for o printed on the o your Microchip S	dentifier only appears in the nber description. This identi- ordering purposes and is not device package. Check with ales Office for package avail- ape and Reel option.	

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APPENDIX A: REVISION HISTORY

Revision A (September 2018)

- Converted Micrel document SY100EL33L to Microchip data sheet DS20006076A.
- Minor text changes throughout.
- Removed all reference to the EOL SY10EL33 and SY100EL33 versions.

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